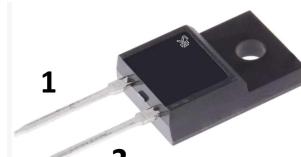
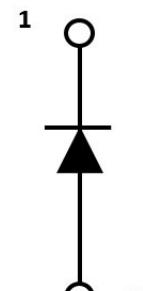


Silicon Carbide Schottky Barrier Diode

1200V, 5A SiC SBD

General Description

The Q-SSC05120-T uses a completely new technology and designs to provide superior switching performances and higher reliability. This device is suitable for use in solar inverter, renewable energy applications, uninterruptible power supply (UPS), and general purpose applications.

Product Summary			TO-220AC	
V _{RRM}	1200	V		
I _F @ T _C =141°C	5	A		
Q _C @ VR=800V	24	nC		
E _c @ VR=800V	12.4	μJ		
Features			Graphic Symbol	
<ul style="list-style-type: none"> Temperature independent switching behavior No reverse recovery current / No forward recovery Excellent thermal performances High surge current capability 				
Applications				
<ul style="list-style-type: none"> Solar inverter / Renewable energy applications Uninterruptible power supply Power factor correction Motor drives 				

Maximum Ratings (T_A=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	1200	V
Continuous Forward Current, D=1	T _C =25°C	17.7	A
	T _C =141°C	5	
Non-Repetitive Peak Forward Surge Current, Half Sine Wave, 10ms	T _C =25°C	51	A
	T _C =150°C	42.5	
i ² t Value, 10ms	∫i ² dt	13	A
Non-Repetitive Peak Forward Current, 10us	I _{F,max}	306	A
Power Dissipation	P _D	90.8	W
Storage Temperature Range	T _{STG}	-55 to 150°C	°C
Operating Junction Temperature Range	T _J	-55 to 175°C	°C

Thermal Characteristics

Parameter	Symbol	Conditions	Min.	Typ	Max	Unit
Maximum Junction-to-Ambient ¹	R _{thJA}	TO-220AC	-	1.18	1.65	°C/W
Maximum Junction-to-Case ¹	R _{thJC}	TO-220AC	-	-	60	°C/W

Electrical Characteristics (T_A=25°C unless otherwise noted)

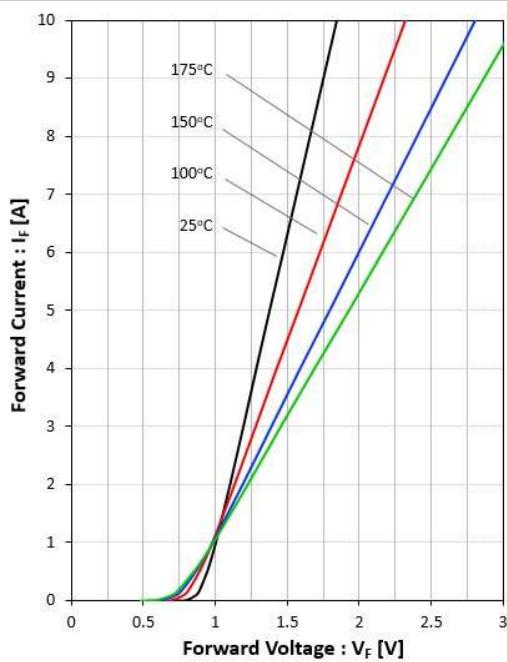
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
STATIC CHARACTERISTICS						
DC Blocking Voltage	V _R	I _R =100uA, T _j =25°C	1200	-	-	V
		I _R =100uA, T _j =175°C	1200	-	-	
Forward Voltage	V _F	I _F =5A, T _j =25°C	-	1.4	1.8	V
		I _F =5A, T _j =150°C	-	1.8	2.2	
		I _F =5A, T _j =175°C	-	1.9	2.4	
Reverse Current	I _R	V _R =1200V, T _j =25°C	-	1	50	μA
		V _R =1200V, T _j =150°C	-	10	100	
		V _R =1200V, T _j =175°C	-	15	200	
DYNAMIC CHARACTERISTICS						
Total Capacitive Charge	Q _C	V _R =800V, T _j =25°C $Q_C = \int_0^{V_R} C(V)dV$	-	24	-	nC
Total Capacitance	C	V _R =0.1V, f=1MHz, T _j =25°C	-	385	-	pF
		V _R =400V, f=1MHz, T _j =25°C	-	26	-	
		V _R =800V, f=1MHz, T _j =25°C	-	19	-	
Capacitance Stored Energy	E _C	V _R =800V, f=1MHz, T _j =25°C	-	12.4	-	μJ

Notes:

1. Heat sink size: 25 x 17 x 4 cm³
2. Pulse Test: Pulse Width ≤300μs, Duty Cycle≤ 2%.
3. The power dissipation is limited by 175°C junction temperature.
4. The data is theoretically the same as I_F and I_{FSM} in real applications, should be limited by total power dissipation.

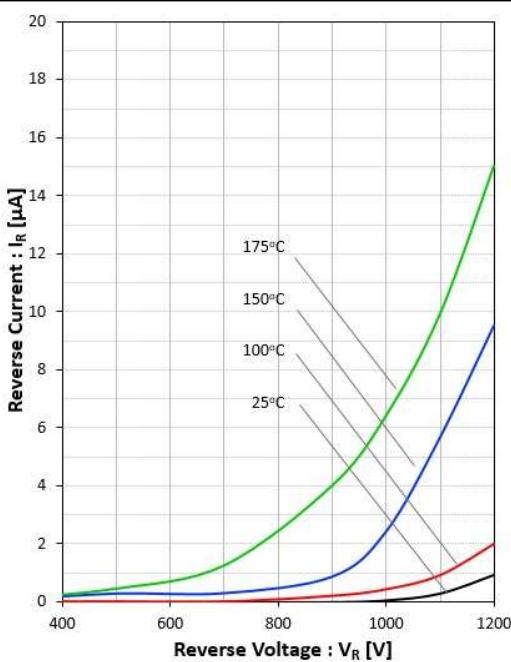
Typical Operating Characteristics

Figure 1: Typical Forward Characteristics



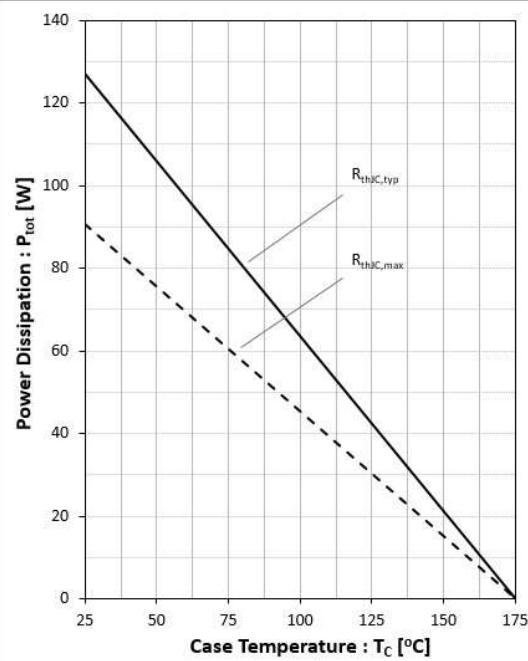
$$I_F = f(V_F, T_j)$$

Figure 2: Typical Reverse Characteristics



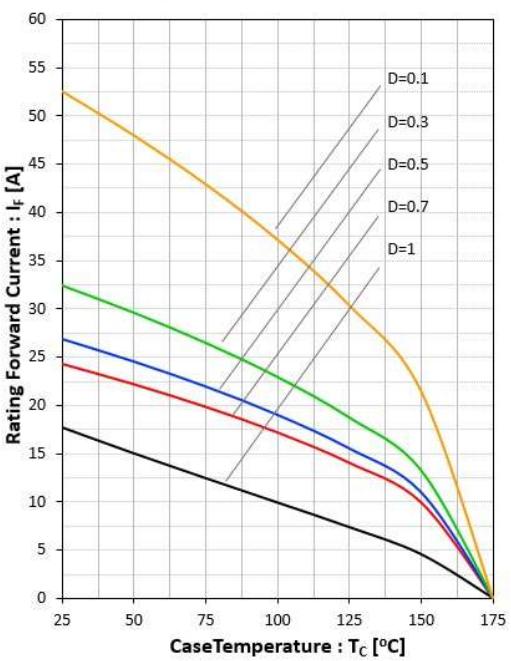
$$I_R = f(V_R, T_j)$$

Figure 3: Power Derating Curves



$$P_{tot} = f(T_C); T_j=175^\circ\text{C}$$

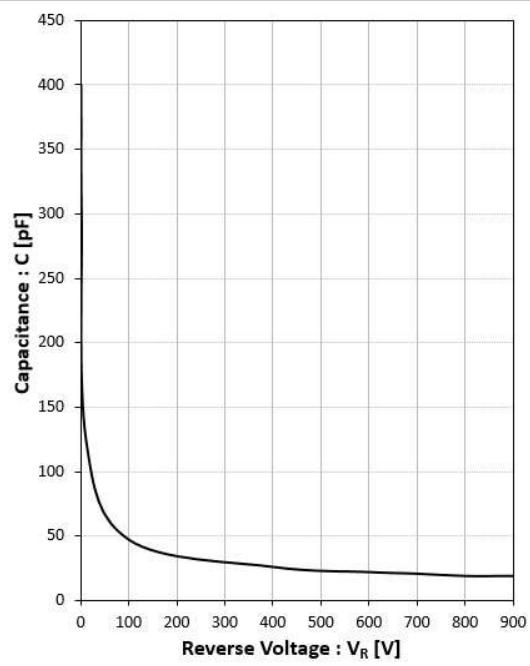
Figure 4: Current Derating Curves



$$I_F = f(T_C); R_{thJC,max}; V_{F,max}; T_j \leq 175^\circ\text{C}; D=t_p/T$$

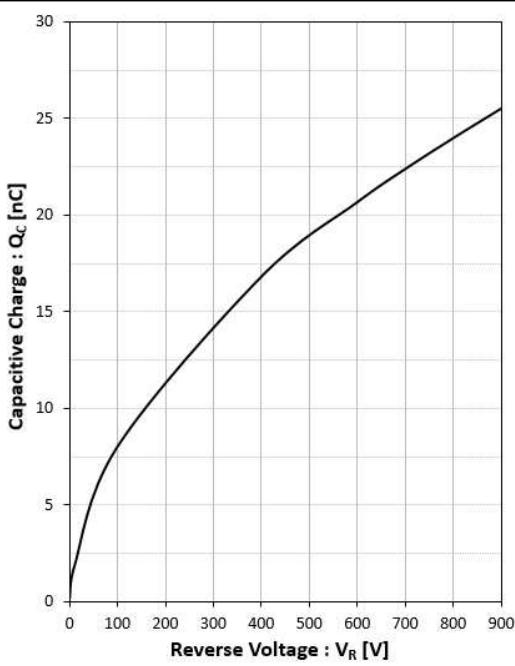
Typical Operating Characteristics (Cont.)

Figure 5: Typical Junction Capacitance



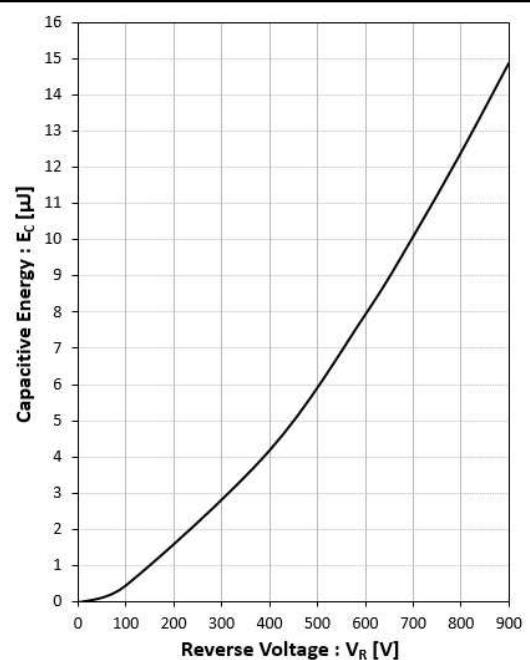
$C = f(V_R)$; $f=1\text{MHz}$

Figure 6: Typical Capacitive Charge



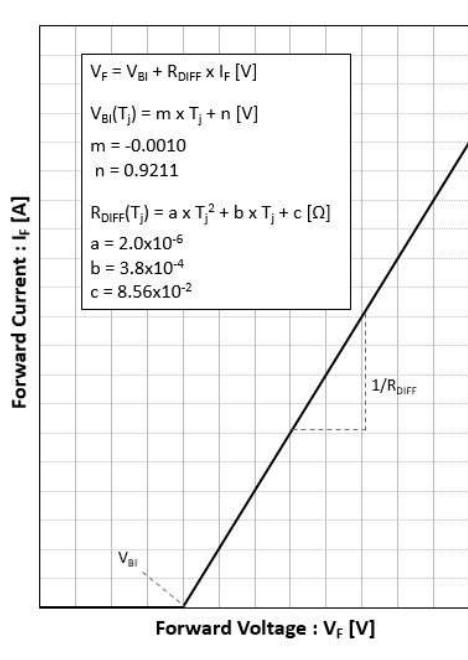
$Q_C = f(V_R)$; $f=1\text{MHz}$

Figure 7: Typical Capacitive Energy



$E_C = f(V_R)$; $f=1\text{MHz}$

Figure 8: Forward Curve Model



$I_F = f(V_F, T_j)$

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

TO-220AC
